

### Description

The DMP3125L uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

## **General Features**

 $V_{DS} = -30V, I_D = -4.1A$  $R_{DS(ON)} < 56m\Omega @ V_{GS} = 10V$ 

# Application

High power and current handing capability Lead free product is acquired Surface mount package PWM applications Load switch Power management

## Package Marking and Ordering Information

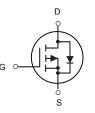
Product ID	Pack	Brand	Qty(PCS)
DMP3125L	SOT-23	HXY MOSFET	3000

## Absolute Maximum Ratings (T<sub>A</sub>=25<sup>°</sup>C unless otherwise noted)

Symbol	Parameter	Limit	Unit	
Vds	Drain-Source Voltage	-30	V	
Vgs	Gate-Source Voltage	±20	V	
l <sub>D</sub>	Drain Current-Continuous	-4.1	A	
DM	Drain Current-Pulsed (Note 1)	-13	A	
PD	Maximum Power Dissipation	1.32	W	
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C	
Reja	Thermal Resistance, Junction-to-Ambient (Note 2)	125	°C <b>/W</b>	







P-Channel MOSFET



Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =-250uA	-30			V	
∆BV <sub>DSS</sub> /∆T <sub>J</sub>	BVDSS Temperature Coefficient	Reference to $25^{\circ}$ C , I <sub>D</sub> =-1mA		-0.02		V/°C	
Rds(on)	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =-10V , I <sub>D</sub> =-3A		48	56	mΩ	
	Static Drain-Source On-Resistance-	V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-1.5A		78	90		
$V_{GS(th)}$	Gate Threshold Voltage		-1.2	-1.5	-2.5	V	
$ riangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	VGS-VDS, ID2300A		4.32		mV/°C	
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =-24V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			-1	-1 -5 uA	
		V <sub>DS</sub> =-24V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			-5		
Igss	Gate-Source Leakage Current	$V_{GS}=\pm 20V$ , $V_{DS}=0V$			±100	nA	
gfs	Forward Transconductance	V <sub>DS</sub> =-5V , I <sub>D</sub> =-3A		4.8		S	
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		24	48	Ω	
Qg	Total Gate Charge (-4.5V)			5.22	7.3	nC	
Qgs	Gate-Source Charge	$V_{\text{DS}}\text{=-}20\text{V}$ , $V_{\text{GS}}\text{=-}4.5\text{V}$ , $I_{\text{D}}\text{=-}3\text{A}$		1.25	1.8		
$\mathbf{Q}_{gd}$	Gate-Drain Charge			2.3	3.2		
T <sub>d(on)</sub>	Turn-On Delay Time			18.4	37		
Tr	Rise Time	$V_{\text{DD}}\text{=-15V}$ , $V_{\text{GS}}\text{=-10V}$ , $R_{\text{G}}\text{=}3.3\Omega$		11.4	21	- ns	
T <sub>d(off)</sub>	Turn-Off Delay Time	ID=-1A		39.4	79		
Tf	Fall Time			5.2	10.4		
Ciss	Input Capacitance			463	650		
Coss	Output Capacitance	$V_{DS}$ =-15V , $V_{GS}$ =0V , f=1MHz		82	115	pF	
Crss	Reverse Transfer Capacitance			68	95		
ls	Continuous Source Current <sup>1,4</sup>				-3.2	А	
I <sub>SM</sub>	Pulsed Source Current <sup>2,4</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			-13	А	
Vsd	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =-1A , T <sub>J</sub> =25°C			-1	V	

Note :

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width  $\,\leq\,$  300us , duty cycle  $\,\leq\,$  2%

3. The power dissipation is limited by 150°C junction temperature

4. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



#### **Typical Characteristics**

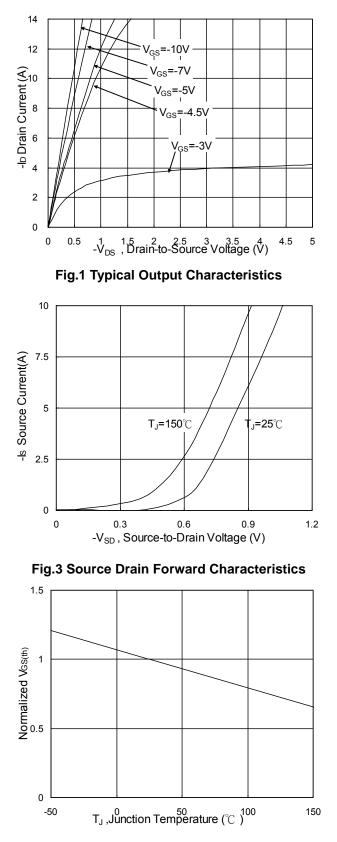


Fig.5 Normalized V<sub>GS(th)</sub> vs. T<sub>J</sub>

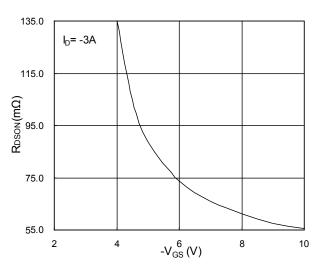


Fig.2 On-Resistance vs. G-S Voltage

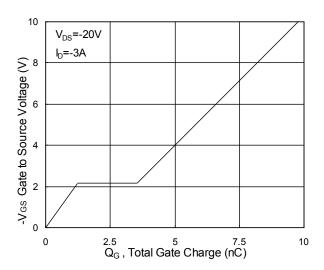


Fig.4 Gate-Charge Characteristics

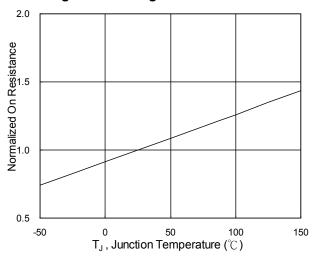
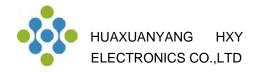


Fig.6 Normalized RDSON vs. TJ



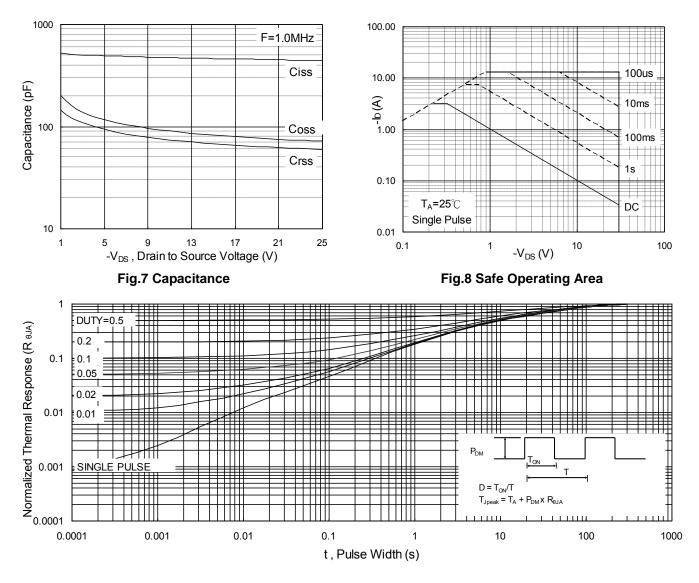


Fig.9 Normalized Maximum Transient Thermal Impedance

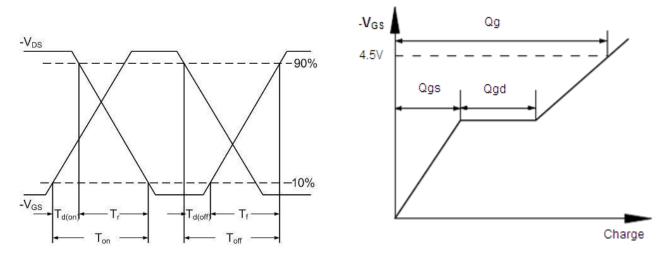
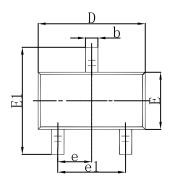


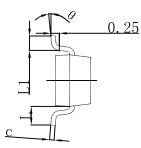
Fig.10 Switching Time Waveform

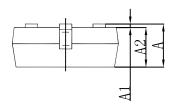
Fig.11 Gate Charge Waveform



# **SOT-23 Package Outline Dimensions**

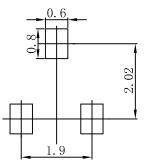






Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

# SOT-23 Suggested Pad Layout



Note: 1.Controlling dimension:in millimeters.

2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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